



High Performance LVPECL Fanout Buffer

Features

- → 4 LVPECL Outputs
- → Up to 1.5GHz Output Frequency
- → Ultra Low Additive Phase Jitter: < 0.03 ps (typ) (differential 156.25MHz, 12KHz to 20MHz integration range)
- → Two selectable inputs
- → Low delay from input to output (Tpd typ. 1.5ns)
- \rightarrow 2.5V / 3.3V power supply
- → Industrial temperature support
- → Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- → Halogen and Antimony Free. "Green" Device (Note 3)
- → For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

- → Packaging (Pb-free & Green):
 - 20-pin, TSSOP (L)

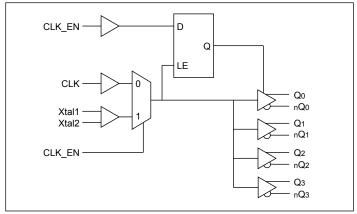
Description

The PI6C4911504-03 is a high performance fanout buffer device which supports up to 1.5GHz frequency. PI6C4911504-03 features selectable single-ended clock or crystal inputs and translates to four LVPECL outputs. The outputs are synchronized with input clock during asynchronous assertion /deassertion of CLK_EN pin. PI6C4911504-03 is ideal for crystal or LVCMOS/LVTTL to LVPECL translation. Typical clock translation and distribution applications are data-communications and telecommunications. This device is ideal for systems that need to distribute low jitter clock signals to multiple destinations.

Applications

- → Networking systems including switches and Routers
- → High frequency backplane based computing and telecom platforms

Block Diagram



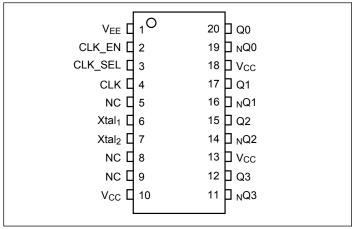
Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.





Pin Configuration



Pin Description

Pin #	Pin Name	Ту	pe	Description
1	V_{EE}	Power		Negative power supply
2	CLK_EN	Input	Pullup	Clock output enable/ disable
3	CLK_SEL	Input	Pulldown	Clock input source selection pin
4	CLK	Input	Pulldown	Clock input
5	NC	-		No Connect
6	XTAL1	Input		Xtal input
7	XTAL2	Output		Xtal output
8, 9	NC	-		No connect
10, 13, 18	V _{CC}	Power		Power supply
11, 12	nQ3	Output		LVPECL output clock
11, 12	Q3	Output		LV FECE output clock
14, 15	nQ2	Outroot	nQ2	LVPECL output clock
14, 13	Q2	Output		LV FECE output clock
16, 17	nQ1	Output		LVPECL output clock
10, 17	Q1	Output		LV FECL output clock
10.20	nQ0	Output		LVPECL output clock
19, 20	Q0	Output		LV FECE output clock

Note: Pullup and Pulldown are for internal input resistors

Function Table

Table 1: Clock source input select function

CLK_SEL Function	
0	CLK is the selected reference input
1	XTAL is the selected input

Table 2: Clock output select function

	CLK_EN	Function
0 All outputs disabled. Qx di		All outputs disabled. Qx disabled low, nQx disabled High
1 All outputs enabled.		All outputs enabled.





Maximum Ratings (Above which the useful life may be impaired. For user guidelines, not tested)

Storage temperature55 to +150°C
Supply Voltage to Ground Potential (VCC)0.5 to +4.65V
Inputs (Referenced to GND)0.5 to Vcc+0.5V
Clock Output (Referenced to GND)0.5 to Vcc+0.5V
Soldering Temperature (Max of 10 seconds)+260°C
Latch up200mA
Junction TemperatureMax. 125°C

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Power Supply Characteristics and Operating Conditions

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
V	Supply Voltage		3.135		3.465	V
V_{CC}	Supply Voltage		2.375		2.625	V
I_{DD}	Power Supply Current	All outputs unloaded			130	mA
T _A	Ambient Operating Temperature		-40		85	°C

DC Electrical Specifications - LVCMOS Inputs

Symbol	Parameter	Conditions		Min.	Typ.	Max.	Units
V_{IH}	Input high voltage		V _{CC} =3.3V	2.0		V _{CC} +0.3	V
V_{IL}	Input low voltage		V _{CC} =3.3V	-0.3		0.8	V
V _{IH}	Input high voltage		V _{CC} =2.5V	1.7		V _{CC} +0.3	V
V _{IL}	Input low voltage		V _{CC} =2.5V	-0.3		0.7	V
т	T. ATT. 1	CLK, CLK_SEL				150	uA
I_{IH}	Input High current	CLK_EN				10	uA
ī	Input Low current	CLK, CLK_SEL		-10			uA
I_{IL}	input Low current	CLK_EN		-150			uA
C_{IN}	Input capacitance				4		pF
R _{PULLUP/PULL} - DOWN	Input pullup and pulldown resistor				50		kΩ

DC Electrical Specifications- LVPECL Outputs

Parameter	Description	Conditions	Min.	Тур.	Max.	Units
V _{OH}	Output High voltage	$V_{CC}=3.3V$	2.1		2.6	V
		V _{CC} =2.5V	1.3		1.75	
V _{OL}	Output Low voltage	$V_{CC}=3.3V$	1.0		1.8	V
		V _{CC} =2.5V	0.4		0.8	





AC Electrical Specifications – Differential Outputs

Parameter	Description	Conditions	Min.	Тур.	Max.	Units
F _{OUT}	Clock output frequency	LVPECL			1500	MHz
$T_{\rm r}$	Output rise time	From 20% to 80%		150		ps
$T_{\rm f}$	Output fall time	From 80% to 20%		150		ps
T _{ODC}	Output duty cycle		48		52	%
V _{PP}	Output swing Single-ended	LVPECL outputs	400			mV
T _j	Buffer additive jitter RMS			0.03		ps
T_{SK}	Output Skew	4 outputs devices, outputs in same bank, with same load, at DUT.		25		ps
T_{PD}	Propagation Delay			1500		ps
T_{OD}	Valid to HiZ		200			ns
T _{OE}	HiZ to valid		200			ns

Notes:

All parameters are measured with CMOS input of 266MHz unless stated otherwise

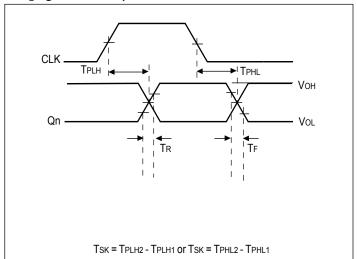
Crystal Characteristics

Parameters	Test Conditions	Min.	Тур.	Max.	Units
Mode of Oscillation		Fundamental			
Frequency		12		50	MHz
Equivalent Series Resistance (ESR)				50	Ω
Shunt Capacitance				7	pF
Drive Level				1	mW

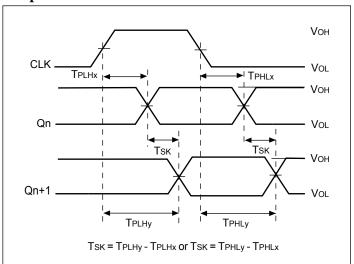




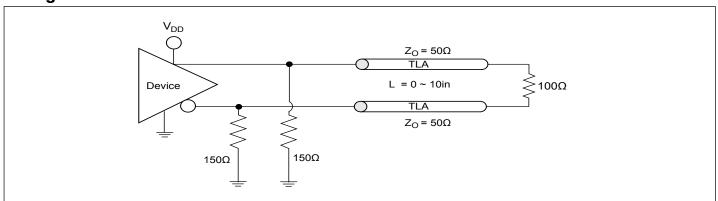
Propagation Delay



Output Skew



Configuration Test Load Board Termination for LVPECL



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Part Marking

PI6C4911 504-03LIE ZYYWWXX

Z: Die Rev YY: Year

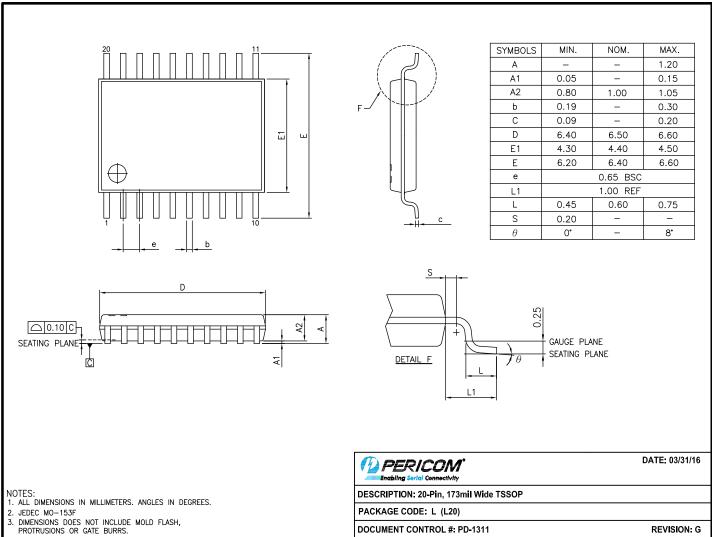
WW: Workweek

1st X: Assembly Code 2nd X: Fab Code





Packaging Mechanical: 20-TSSOP (L)



16-0074

For latest package info.

please check: http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/

Ordering Information

Ordering Number	Package Code	Package Description
PI6C4911504-03LIEX	L	20-Pin, 173mil Wide (TSSOP)

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. E = Pb-free and Green
- 5. X suffix = Tape/Reel





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